TOSHIBA Field-Effect Transistor Silicon N-Channel MOS Type

SSM3K36TU

High-Speed Switching Applications

Unit: mm

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• Low ON-resistance: $R_{on} = 1.52 \Omega \text{ (max) } (@V_{GS} = 1.5 \text{ V})$

: R_{on} = 1.14 Ω (max) (@V_{GS} = 1.8 V)

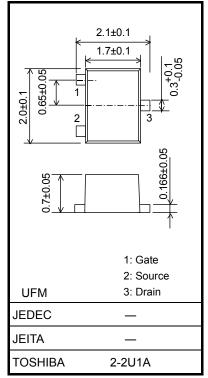
: $R_{on} = 0.85 \Omega \text{ (max) } (@V_{GS} = 2.5 \text{ V})$

: $R_{on} = 0.66 \Omega \text{ (max) } (@V_{GS} = 4.5 \text{ V})$

: $R_{on} = 0.63 \Omega \text{ (max) (@V_{GS} = 5.0 V)}$

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage	V_{DSS}	20	V		
Gate-source voltage	V _{GSS}	± 10	V		
Drain current	DC	I _D	500	mA	
Drain current	Pulse	I _{DP}	1000		
Drain power dissipation		P _D (Note 1)	500	mW	
		P _D (Note 2)	800		
Channel temperature		T _{ch}	150	°C	
Storage temperature	T _{stg}	–55 to 150	°C		



Weight: 6.6 mg (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the

reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Equivalent Circuit (top view)

Note1: Mounted on an FR4 board

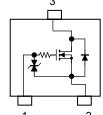
 $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{ mm}, \text{ Cu Pad: } 645 \text{ mm}^2)$

Note2: Mounted on a ceramic board.

(25.4 mm \times 25.4 mm \times 0.8 mm, Cu Pad: 645 mm²)

Marking

3



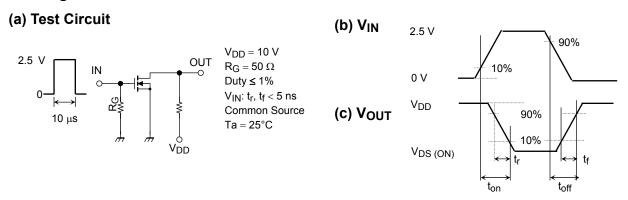
Start of commercial production 2008-02

Electrical Characteristics (Ta = 25°C)

Chara	acteristics	Symbol	Test Conditions	Min	Тур.	Max	Unit
Drain-source breakdown voltage		V (BR) DSS	$I_D = 1 \text{ mA}, V_{GS} = 0$	20	_	_	V
		V (BR) DSX	I _D = 1 mA, V _{GS} = - 10 V	12	_	_	
Drain cutoff current		I _{DSS}	V _{DS} =20 V, V _{GS} = 0	_	_	1	μА
Gate leakage current		I _{GSS}	$V_{GS} = \pm 10 \text{ V}, V_{DS} = 0$	_	_	±1	μА
Gate threshold voltage		V _{th}	$V_{DS} = 3 \text{ V}, I_D = 1 \text{ mA}$	0.35	_	1.0	V
Forward transfer admittance		Y _{fs}	$V_{DS} = 3 \text{ V}, I_D = 200 \text{ mA}$ (Note3)	420	840	_	mS
Drain-source ON-resistance		RDS (ON)	$I_D = 200 \text{ mA}, V_{GS} = 5.0 \text{ V}$ (Note3)	_	0.46	0.63	Ω
			I _D = 200 mA, V _{GS} = 4.5 V (Note3)	_	0.51	0.66	
			I _D = 200 mA, V _{GS} = 2.5 V (Note3)	_	0.66	0.85	
			I _D = 100 mA, V _{GS} = 1.8 V (Note3)	_	0.81	1.14	
			$I_D = 50 \text{ mA}, V_{GS} = 1.5 \text{ V}$ (Note3)	_	0.95	1.52	
Input capacitance		C _{iss}		_	46	_	pF
Output capacitance		Coss	V _{DS} = 10 V, V _{GS} = 0, f = 1 MHz	_	10.8	_	
Reverse transfer capacitance		C _{rss}		_	7.3	_	
Total Gate Charge		Qg		_	1.23	_	nC
Gate-Source Charge		Q _{gs}	V_{DS} = 10V, I_{D} = 0.5 A, V_{GS} = 4.0 V	_	0.60	_	
Gate–Drain Charge		Q _{gd}		_	0.63		
Switching time	Turn-on time	t _{on}	V _{DD} = 10 V, I _D = 200 mA	_	30		- ns
	Turn-off time	t _{off}	V_{GS} = 0 to 2.5 V, R_G = 50 Ω	_	75		
Drain-source forward voltage		V _{DSF}	$I_D = -0.5 \text{ A}, V_{GS} = 0 \text{ V}$ (Note2)	_	-0.88	-1.2	V

Note2: Pulse test

Switching Time Test Circuit



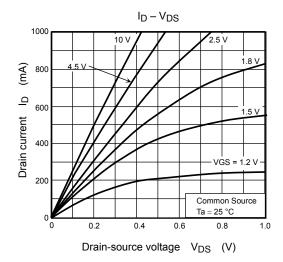
Usage Considerations

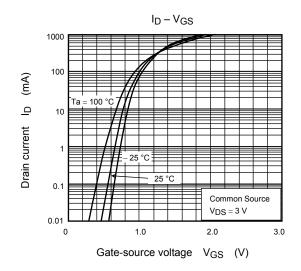
Let V_{th} be the voltage applied between gate and source that causes the drain current (I_D) to below (1 mA for the SSM3K36TU). Then, for normal switching operation, $V_{GS(on)}$ must be higher than V_{th} , and $V_{GS(off)}$ must be lower than V_{th} . This relationship can be expressed as: $V_{GS(off)} < V_{th} < V_{GS(on)}$. Take this into consideration when using the device.

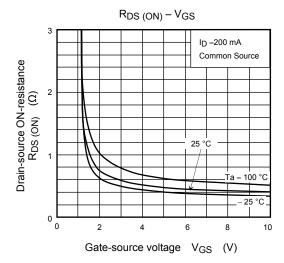
Handling Precaution

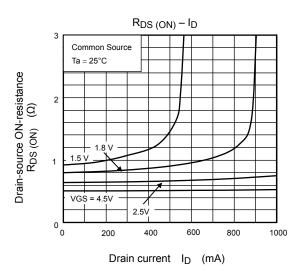
When handling individual devices that are not yet mounted on a circuit board, make sure that the environment is protected against electrostatic discharge. Operators should wear antistatic clothing, and containers and other objects that come into direct contact with devices should be made of antistatic materials.

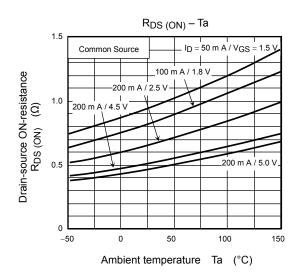
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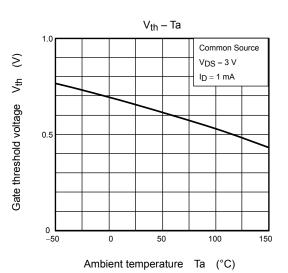


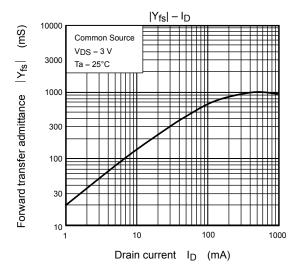


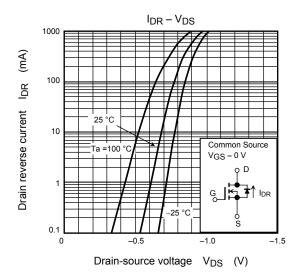


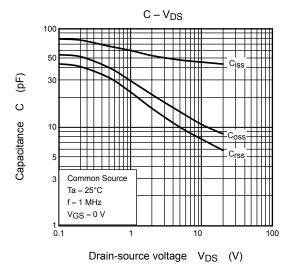


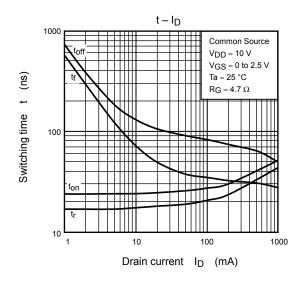


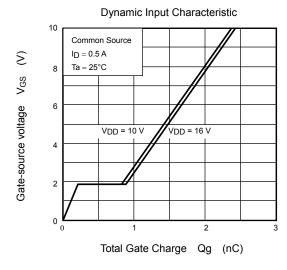


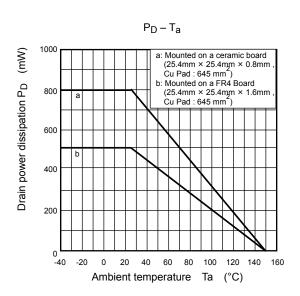












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